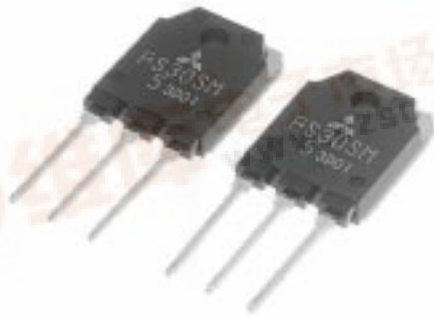


MITSUBISHI Nch POWER MOSFET

# FS30SM-5

HIGH-SPEED SWITCHING USE

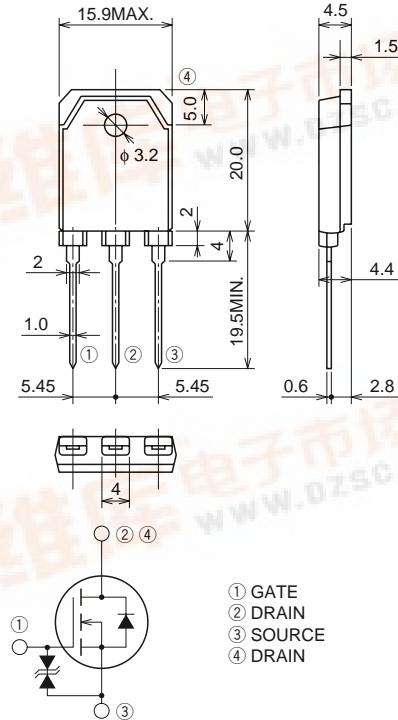
## FS30SM-5



- V<sub>DSS</sub> ..... 250V
- r<sub>DS (ON)</sub> (MAX) ..... 0.13Ω
- I<sub>D</sub> ..... 30A

## OUTLINE DRAWING

Dimensions in mm



TO-3P

## APPLICATION

SMPS, DC-DC Converter, battery charger, power supply of printer, copier, HDD, FDD, TV, VCR, personal computer etc.

## MAXIMUM RATINGS (T<sub>c</sub> = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>DSS</sub>	Drain-source voltage	V <sub>GS</sub> = 0V	250	V
V <sub>GSS</sub>	Gate-source voltage	V <sub>DS</sub> = 0V	±30	V
I <sub>D</sub>	Drain current		30	A
I <sub>DM</sub>	Drain current (Pulsed)		90	A
P <sub>D</sub>	Maximum power dissipation		250	W
T <sub>ch</sub>	Channel temperature		-55 ~ +150	°C
T <sub>stg</sub>	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	4.8	g

# FS30SM-5

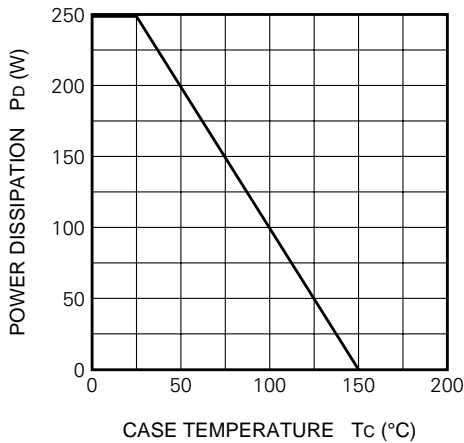
## HIGH-SPEED SWITCHING USE

### ELECTRICAL CHARACTERISTICS (T<sub>ch</sub> = 25°C)

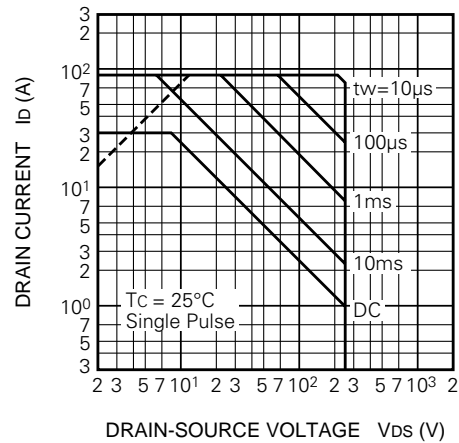
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V	250	—	—	V
V(BR)GSS	Gate-source breakdown voltage	I <sub>G</sub> = ±100μA, V <sub>DS</sub> = 0V	±30	—	—	V
I <sub>GSS</sub>	Gate-source leakage current	V <sub>GS</sub> = ±25V, V <sub>DS</sub> = 0V	—	—	±10	μA
I <sub>DSS</sub>	Drain-source leakage current	V <sub>DS</sub> = 250V, V <sub>GS</sub> = 0V	—	—	1	mA
V <sub>GS(th)</sub>	Gate-source threshold voltage	I <sub>D</sub> = 1mA, V <sub>DS</sub> = 10V	2	3	4	V
r <sub>DS(ON)</sub>	Drain-source on-state resistance	I <sub>D</sub> = 15A, V <sub>GS</sub> = 10V	—	0.10	0.13	Ω
V <sub>DS(ON)</sub>	Drain-source on-state voltage	I <sub>D</sub> = 15A, V <sub>GS</sub> = 10V	—	1.5	1.95	V
y <sub>fs</sub>	Forward transfer admittance	I <sub>D</sub> = 15A, V <sub>DS</sub> = 10V	10.0	15.0	—	S
C <sub>iss</sub>	Input capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz	—	2100	—	pF
C <sub>oss</sub>	Output capacitance		—	420	—	pF
C <sub>rss</sub>	Reverse transfer capacitance		—	90	—	pF
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 150V, I <sub>D</sub> = 15A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = R <sub>GS</sub> = 50Ω	—	35	—	ns
t <sub>r</sub>	Rise time		—	85	—	ns
t <sub>d(off)</sub>	Turn-off delay time		—	240	—	ns
t <sub>f</sub>	Fall time		—	100	—	ns
V <sub>SD</sub>	Source-drain voltage	I <sub>S</sub> = 15A, V <sub>GS</sub> = 0V	—	1.5	2.0	V
R <sub>th(ch-c)</sub>	Thermal resistance	Channel to case	—	—	0.50	°C/W

### PERFORMANCE CURVES

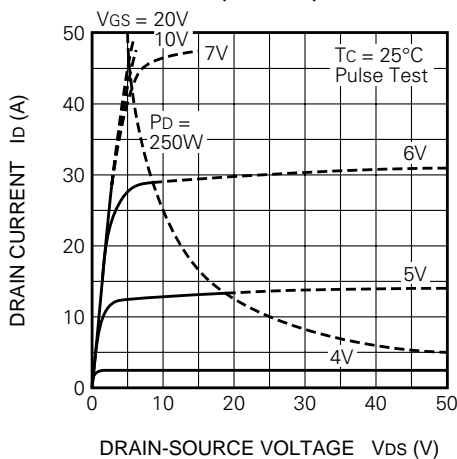
POWER DISSIPATION DERATING CURVE



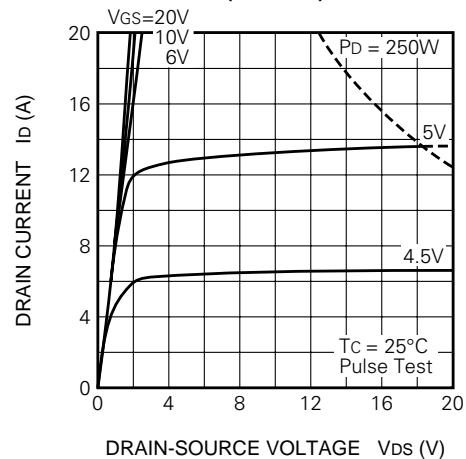
MAXIMUM SAFE OPERATING AREA



OUTPUT CHARACTERISTICS (TYPICAL)



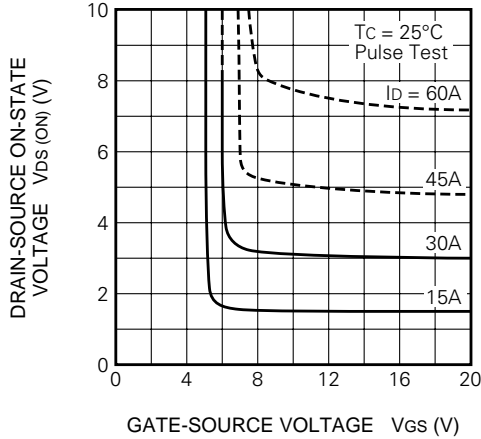
OUTPUT CHARACTERISTICS (TYPICAL)



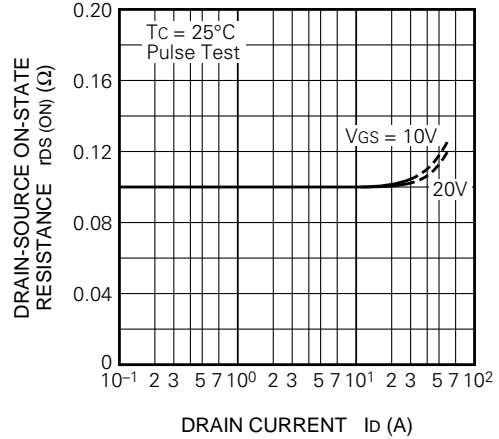
# FS30SM-5

## HIGH-SPEED SWITCHING USE

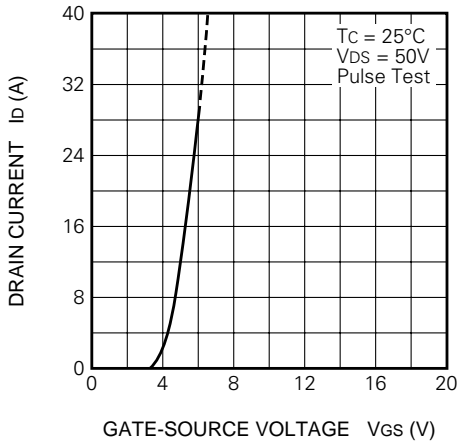
**ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)**



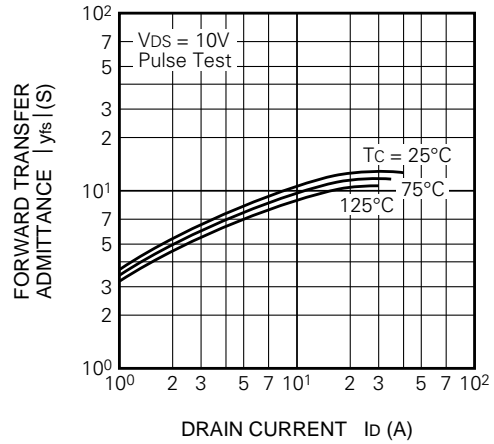
**ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)**



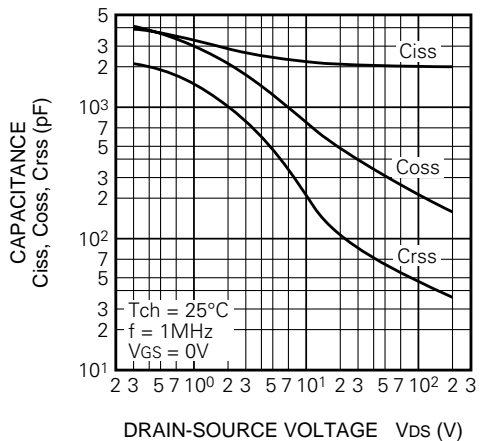
**TRANSFER CHARACTERISTICS (TYPICAL)**



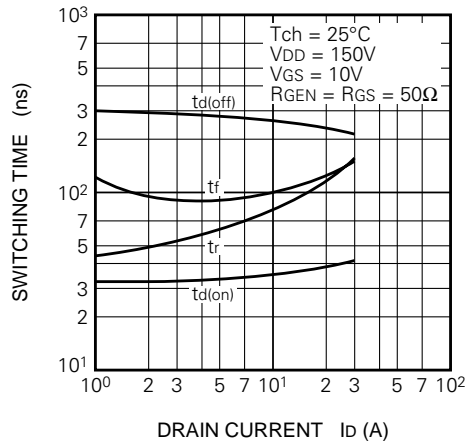
**FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)**



**CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)**



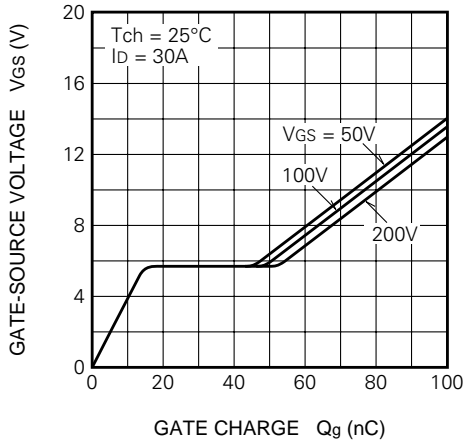
**SWITCHING CHARACTERISTICS (TYPICAL)**



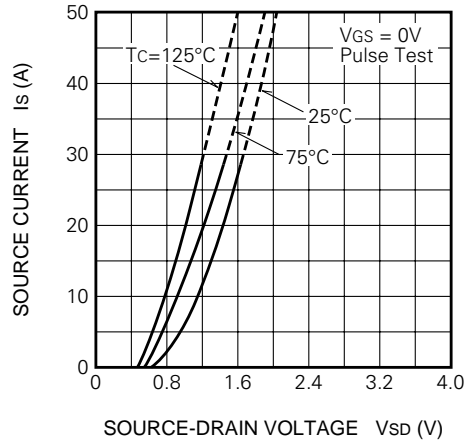
# FS30SM-5

HIGH-SPEED SWITCHING USE

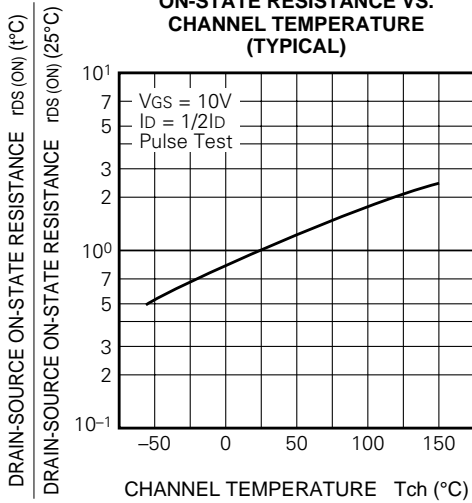
**GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)**



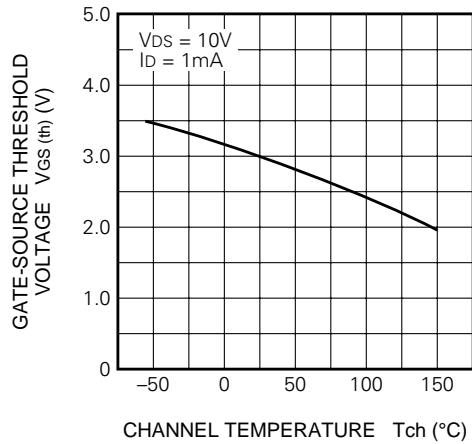
**SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)**



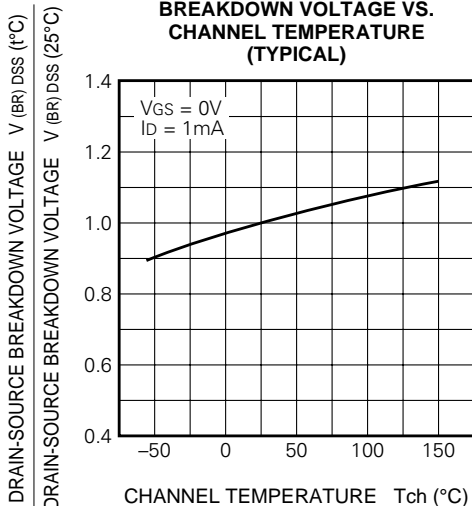
**ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)**



**THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)**



**BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)**



**TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS**

